

APPROVAL SHEET

WF25S, WF20S, WF12S, WF08S, WF06S

±5%, ±10%, ±20%

Power Surge Chip Resistors

Size 2512, 2010, 1206, 0805, 0603

FEATURE

- 1. Power rating and compact size
- 2. High reliability and stability
- 3. Reduced size of final equipment
- 4. Surge protection

APPLICATION

- Power supply
- Measurement instrument
- Automotive industry
- Medical or Military equipment

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to request resistance to nominal value within tolerance which controlled by printing process in this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (Pb free) alloy.

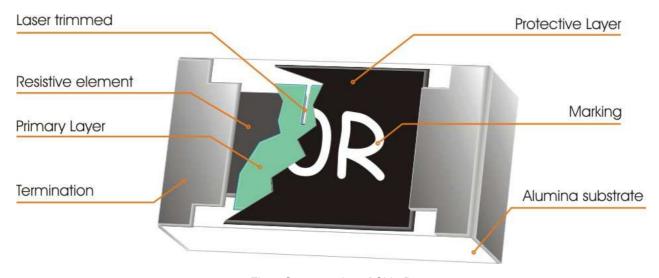


Fig 1. Consctruction of Chip-R

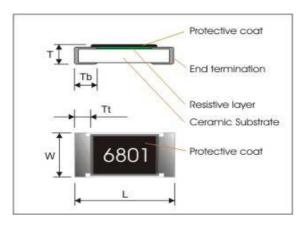
QUICK REFERENCE DATA

Item	General Specification					
Series No.	WF25S	WF20S	WF12S	WF08S	WF06S	
Size code	2512(6432)	2010 (5025)	1206 (3216)	0805 (2012)	0603 (1608)	
Resistance Tolerance		<u> </u>	5% ±10% ±20% (E	24)		
Resistance Range		1Ω ~ 1ΜΩ				
TCR (ppm/°C)	± 100 ppm /°C					
Max. dissipation at T _{amb} =70°C	1 W	1/2W	1/4W	1/8W	1/10 W	
Max. Operation Voltage (DC or RMS)	200V	200V	200V	150V	50V	
Max. Overload Voltage (DC or RMS)	400V	400V	400V	300V	100V	
Climatic category (IEC 60068)		55/155/56				

Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by $RCWV = \sqrt{Rated Power \times Resistance Value} \quad \text{or Max. RCWV listed above, whichever is lower.}$

MECHANICAL DATA(unit: mm)



Symbol	WF25S	WF20S	WF12S	WF08S	WF06S
L	6.30±0.20	5.00±0.20	3.10±0.15	2.00±0.15	1.60 ± 0.10
W	3.10±0.20	2.50±0.20	1.60±0.15	1.20±0.15	0.80 ± 0.10
Т	0.60±0.15	0.60±0.10	0.55±0.10	0.50±0.10	0.45 ± 0.15
Tt	0.60±0.25	0.60±0.25	0.50±0.25	0.40±0.20	0.30 ± 0.15
Tb	0.60±0.25	0.60±0.25	0.50±0.25	0.40±0.20	0.30 ± 0.10

MARKING

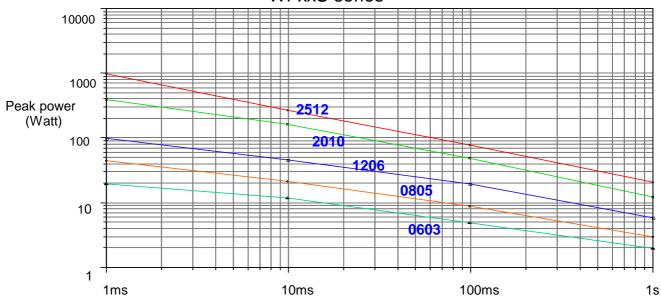
- 1. Each resistor is marked with a three-digit code on the protective coating to designate the nominal resistance value.
- 2. Surge Resistor is prints underline on three-digit code for identification

Example:



Surge Performance

WFxxS series



Surge duration

De-rating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

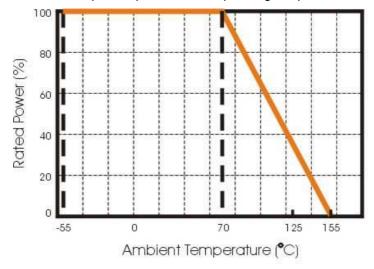


Fig.2 Maximum dissipation in percentage of rated power As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

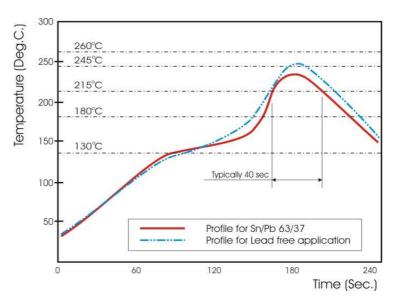


Fig 3. Infrared soldering profile for Chip Resistors WFxxS

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WF20	S	472_	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
WF25 : 2512	S : surge	E24 : 3 significant digits followed	J: ±5%	T: 7" Reeled taping	L = Sn base (lead
WF20 : 2010		by no. of zeros and a blank $472 = 4K7$	K: ±10%		free)
WF12 : 1206			M: ±20%		
WF08:0805					
WF06:0603					

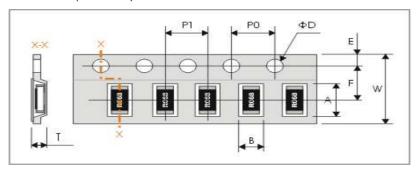


TEST AND REQUIREMENTS(JIS C 5201-1: 1998)

TEST	PROCEDURE	REQUIREMENT
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\times 10^6 \ \ (\text{ppm/°C}) \ \ t_1:20\text{C}+5\text{C}-1\text{C}$	Refer to "QUICK REFERENCE DATA"
	R ₁ : Resistance at reference temperature	
	R ₂ : Resistance at test temperature	
Short time overload (S.T.O.L)	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	Δ R/R max. ±(1%+0.1 Ω)
Clause 4.13		
Resistance to soldering heat(R.S.H)	Un-mounted chips completely immersed for 10±1second in a solder bath at 260°C±5°C	no visible damage \triangle R/R max. \pm (1%+0.05 Ω)
Clause 4.18		,
Solderability Clause	Un-mounted chips completely immersed for 2±0.5second in a solder bath at 235°C ±5°C	good tinning (>95% covered)
Clause 4.17	a solder patri at 255 (±5 (no visible damage
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃, 30	no visible damage
Clause 4.19	minutes at +155°C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 5 cycles	Δ R/R max. ±(1%+0.05 Ω)
Load life (endurance) Clause 4.25	70±2°C, 1000 hours, loaded with RCWV or Vmax,1.5 hours on and 0.5 hours off	Δ R/R max. \pm (3%+0.1 Ω)
Load life in Humidity Clause 4.24	1000 hours, at rated continuous working voltage in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	Δ R/R max. \pm (3%+0.1 Ω)
Bending strength Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 2 mm, once for 10 seconds	Δ R/R max. ±(1%+0.05 Ω)
Adhesion	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or
Clause 4.32		removal of the terminations
Insulation Resistance	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ
Clause 4.6		
Dielectric Withstand	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover
Voltage		
Clause 4.7		

PACKAGING

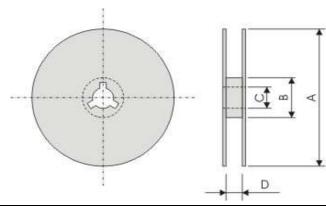
Plastic Tape specifications (unit :mm)



Series No.	А	В	W	F	E
WF25S	6.70±0.20	3.50±0.20	12.00±0.30	5.50±0.05	1.75±0.10
WF20S	5.50±0.20	2.80±0.20	12.00±0.30	3.30±0.03	1.75±0.10
WF12S	3.57±0.20	2.00±0.20			
WF08S	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.05	1.75±0.10
WF06S	1.90±0.20	1.10±0.20			

Series No.	P1	P0	ΦD	Т
WF25S				Max. 1.2
WF20S				IVIAX. 1.2
WF12S	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	Max. 1.0
WF08S				IVIAX. 1.0
WF06S				0.65±0.05

Reel dimensions



Reel / Tape	А	В	С	D
7" reel for 8mm tape	Ф178.0±2.0	& €0.0±4.0	13.0±0.2	9.00±0.50
7" reel for 12mm tape		Φ60.0±1.0		12.4±1.00

- Taping quantity
 -1206 0805 0603 Chip resistors 5,000 pcs per reel.
 -2010 2512 Chip resistors 4,000 pcs per reel.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thick Film Resistors - SMD category:

Click to view products by Walsin manufacturer:

Other Similar products are found below:

CR-05FL7--150R CR-05FL7--19K6 CR-05FL7--243R CR-05FL7--40K2 CR-05FL7--698K CR-12FP4--324R CR-12JP4--680R

M55342K06B6E19RWL M55342K06B6E81RS3 M55342M05B200DRWB M55342M06B4K70MS3 MC0603-511-JTW 742C083750JTR

MCR01MZPF1202 MCR01MZPF1601 MCR01MZPF1800 MCR01MZPF6201 MCR01MZPF9102 MCR01MZPJ113 MCR01MZPJ121

MCR01MZPJ125 MCR01MZPJ751 MCR03EZHJ103 MCR03EZPFX2004 MCR03EZPJ270 MCR03EZPJ821 MCR10EZPF1102

MCR18EZPJ330 RC0603F1473CS RC0603F150CS RC1005F1152CS RC1005F1182CS RC1005F1372CS RC1005F183CS

RC1005F1911CS RC1005F1912CS RC1005F203CS RC1005F2052CS RC1005F241CS RC1005F2431CS RC1005F3011CS

RC1005F303CS RC1005F4321CS RC1005F4642CS RC1005F471CS RC1005F4751CS RC1005F5621CS RC1005F6041CS

RC1005J106CS RC1005J121CS